

## Power MOSFET

# 8A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

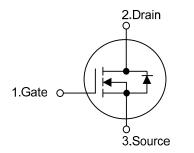
### DESCRIPTION

The **UTC 8NM60A-FD** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

### FEATURES

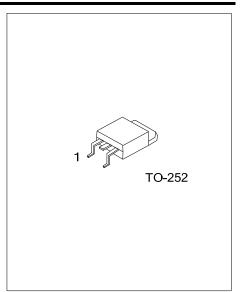
- \*  $R_{DS(ON)}$  < 0.64  $\Omega$  @ V<sub>GS</sub> = 10V, I<sub>D</sub> = 4.0A
- \* Fast Switching Capability
- \* Avalanche Energy Tested
- \* Improved dv/dt Capability, High Ruggedness

### SYMBOL



### ORDERING INFORMATION





## **Power MOSFET**

#### ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	600	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Drain Current	Continuous	I <sub>D</sub>	8	А
	Pulsed (Note 2)	I <sub>DM</sub>	24	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	380	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6	V/ns
Power Dissipation		PD	62	W
Junction Temperature		ТJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L=66mH, I<sub>AS</sub>=3.4A, V<sub>DD</sub>=50V, R<sub>G</sub>=25  $\Omega$ , Starting T<sub>J</sub> = 25°C

4.  $I_{SD} \le 8.0A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

#### THERMAL DATA

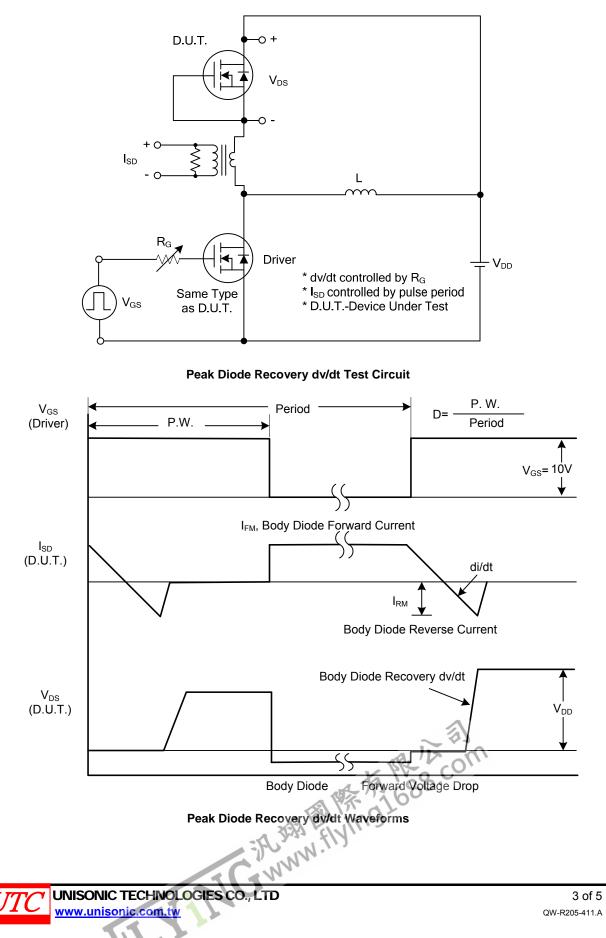
PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	110	°C/W	
Junction to Case	θ <sub>JC</sub>	2	°C/W	

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

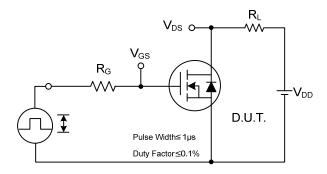
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	
OFF CHARACTERISTICS							51111
Drain-Source Breakdown Voltage	1	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	600	1	1	V
Drain-Source Leakage Current	·	I <sub>DSS</sub>	$V_{DS} = 600V, V_{GS} = 0V$	000		10	μA
	Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate- Source Leakage Current	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS				1	1		
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250µA	2.5		4.5	V
Static Drain-Source On-State Res	sistance	R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 4.0A$			0.64	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		CISS			497		pF
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0 MHz		518		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			59		pF
SWITCHING CHARACTERISTIC	S						
Turn-ON Delay Time (Note 1)		t <sub>D(ON)</sub>			6.4		ns
Rise Time		t <sub>R</sub>	V <sub>DD</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =8.0A,		23.2		ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		56		ns
Fall-Time		t <sub>F</sub>			36.8		ns
SOURCE- DRAIN DIODE RATIN	GS AND CHA	RACTERIS	<u>rics</u>				
Maximum Body-Diode Continuou	s Current	Is				8	Α
Maximum Body-Diode Pulsed Cu	rrent	I <sub>SM</sub>				24	Α
Drain-Source Diode Forward Volt	age (Note 1)	$V_{SD}$	I <sub>S</sub> =8.0A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Ti	me (Note 1)	t <sub>rr</sub>	I <sub>S</sub> =8.0A, V <sub>GS</sub> =0V,	0	162		ns
Body Diode Reverse Recovery C	harge	Qrr	dl <sub>F</sub> /dt=100A/µs		1.08		μC
Notes: 1. Pulse Test: Pulse width	≤ 300µs, Duty	′ cycle≤2%.	A 18 680.				
2. Essentially independent	t of operating to	emperature.	SI 1/5- 10				
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Body Diode Reverse Recovery Time (Note 1) trr Is=8.0A, VGS=0V, OIF   Body Diode Reverse Recovery Charge Qrr dIF/dt=100A/µs   Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%. 2. Essentially independent of operating temperature.   UNISONIC TECHNOLOGIES CO., LTD							2 of 5
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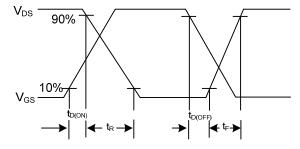
## TEST CIRCUITS AND WAVEFORMS



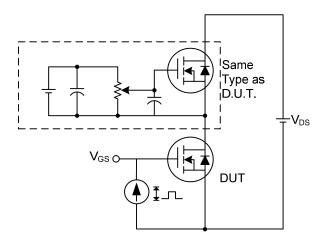
## **TEST CIRCUITS AND WAVEFORMS (Cont.)**



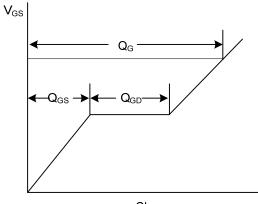
**Switching Test Circuit** 



**Switching Waveforms** 

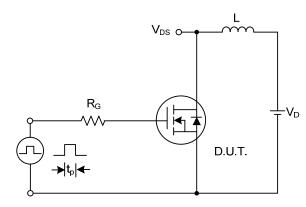


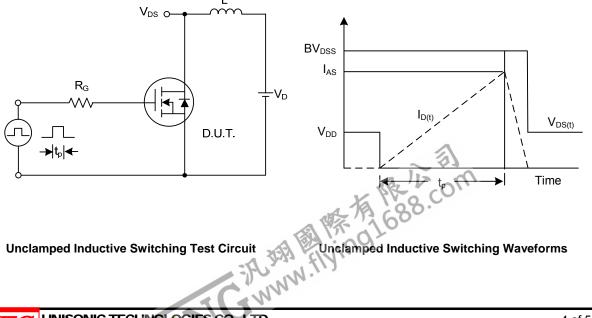




Charge

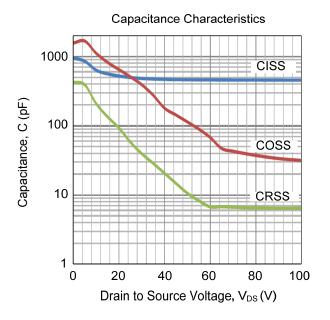








## TYPICAL CHARACTERISTICS



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